

NCV8501 Series

Micropower 150 mA LDO Linear Regulators with **ENABLE**, **DELAY**, **RESET**, and **Monitor Flag**

The NCV8501 is a family of precision micropower voltage regulators. Their output current capability is 150 mA. The family has output voltage options for adjustable, 2.5 V, 3.3 V, 5.0 V, 8.0 V, and 10 V.

The output voltage is accurate within $\pm 2.0\%$ with a maximum dropout voltage of 0.6 V at 150 mA. Low quiescent current is a feature drawing only 90 μA with a 100 μA load. This part is ideal for any and all battery operated microprocessor equipment.

Microprocessor control logic includes an active **RESET** (with **DELAY**), and a flag monitor which can be used to provide an early warning signal to the microprocessor of a potential impending **RESET** signal. The use of the flag monitor allows the microprocessor to finish any signal processing before the **RESET** shuts the microprocessor down.

The active **RESET** circuit operates correctly at an output voltage as low as 1.0 V. The **RESET** function is activated during the power up sequence or during normal operation if the output voltage drops outside the regulation limits.

The regulator is protected against reverse battery, short circuit, and thermal overload conditions. The device can withstand load dump transients making it suitable for use in automotive environments. The device has also been optimized for EMC conditions.

Features

- Output Voltage Options: Adjustable, 2.5 V, 3.3 V, 5.0 V, 8.0 V, 10 V
- $\pm 2.0\%$ Output
- Low 90 μA Quiescent Current
- Fixed or Adjustable Output Voltage
- Active **RESET**
- **ENABLE**
- 150 mA Output Current Capability
- Fault Protection
 - ♦ +60 V Peak Transient Voltage
 - ♦ -15 V Reverse Voltage
 - ♦ Short Circuit
 - ♦ Thermal Overload
- Early Warning through **FLAG/MON** Leads
- NCV Prefix for Automotive and Other Applications Requiring Site and Change Control

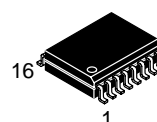


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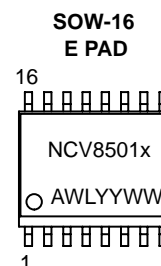
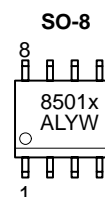


SO-8
D SUFFIX
CASE 751



SOIC 16 LEAD
WIDE BODY
EXPOSED PAD
PDW SUFFIX
CASE 751R

MARKING DIAGRAMS



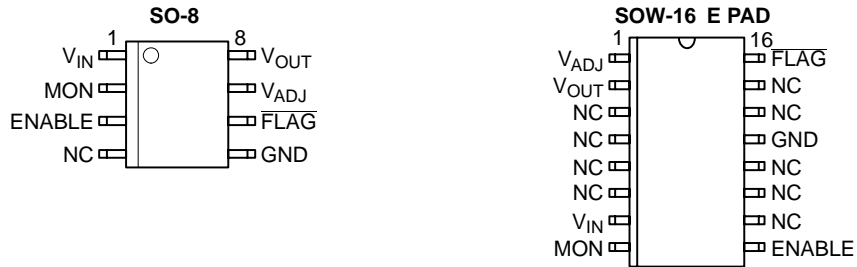
x = Voltage Ratings as Indicated Below:
A = Adjustable
2 = 2.5 V
3 = 3.3 V
5 = 5.0 V
8 = 8.0 V
0 = 10 V
A = Assembly Location
WL, L = Wafer Lot
YY, Y = Year
WW, W = Work Week

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 12 of this data sheet.

NCV8501 Series

PIN CONNECTIONS, ADJUSTABLE OUTPUT



PIN CONNECTIONS, FIXED OUTPUT

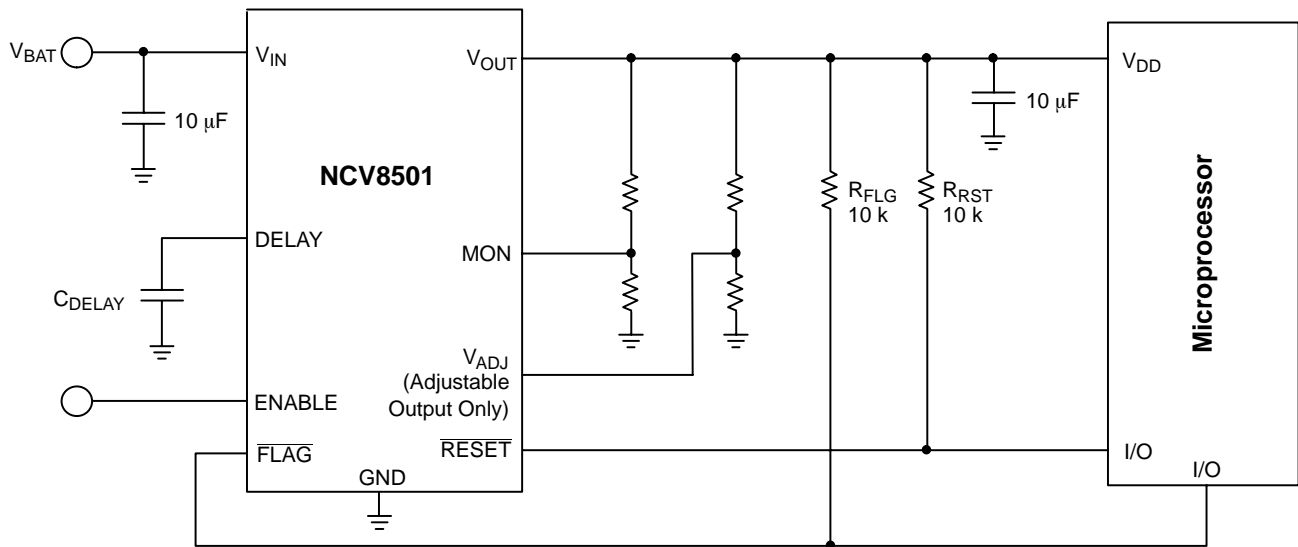
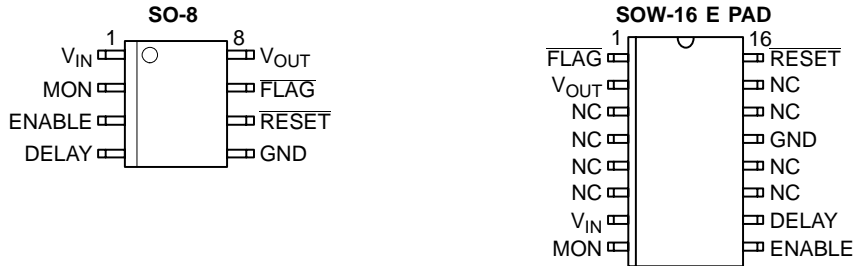


Figure 1. Application Diagram

MAXIMUM RATINGS*†

Rating	Value	Unit
V _{IN} (dc)	-15 to 45	V
Peak Transient Voltage (46 V Load Dump @ V _{IN} = 14 V)	60	V
Operating Voltage	45	V
V _{OUT} (dc)	16	V
Voltage Range (RESET, FLAG)	-0.3 to 10	V
Input Voltage Range (MON)	-0.3 to 10	V

*The maximum package power dissipation must be observed.

†During the voltage range which exceeds the maximum tested voltage of V_{IN}, operation is assured, but not specified. Wider limits may apply. Thermal dissipation must be observed closely.

NCV8501 Series

MAXIMUM RATINGS*† (continued)

Rating	Value	Unit
Input Voltage Range (ENABLE)	-0.3 to 10**	V
ESD Susceptibility (Human Body Model)	2.0	kV
Junction Temperature, T_J	-40 to +150	°C
Storage Temperature, T_S	-55 to 150	°C
Package Thermal Resistance, SO-8: Junction-to-Case, $R_{\theta JC}$ Junction-to-Ambient, $R_{\theta JA}$	45 165	°C/W °C/W
Package Thermal Resistance, SOW-16 E PAD: Junction-to-Case, $R_{\theta JC}$ Junction-to-Ambient, $R_{\theta JA}$ Junction-to-Pin, $R_{\theta JP}$ (Note 1)	15 56 35	°C/W °C/W °C/W
Lead Temperature Soldering: Reflow: (SMD styles only) (Note 2)	240 peak (Note 3)	°C

1. Measured to pin 16.

2. 60 second maximum above 183°C.

3. -5 °C / +0°C allowable conditions.

*The maximum package power dissipation must be observed.

†During the voltage range which exceeds the maximum tested voltage of V_{IN} , operation is assured, but not specified. Wider limits may apply. Thermal dissipation must be observed closely.

**Reference Figure 13 for switched-battery ENABLE application.

ELECTRICAL CHARACTERISTICS ($I_{OUT} = 1.0$ mA, ENABLE = 5.0 V, $-40^{\circ}\text{C} \leq T_A \leq 125^{\circ}\text{C}$; $-40^{\circ}\text{C} \leq T_J \leq 150^{\circ}\text{C}$; V_{IN} dependent on voltage option (Note 4); unless otherwise specified.)

Characteristic	Test Conditions	Min	Typ	Max	Unit
Output Stage					
Output Voltage for 2.5 V Option	$6.5\text{ V} < V_{IN} < 16\text{ V}$, $100\text{ }\mu\text{A} \leq I_{OUT} \leq 150\text{ mA}$	2.450	2.5	2.550	V
	$5.5\text{ V} < V_{IN} < 26\text{ V}$, $100\text{ }\mu\text{A} \leq I_{OUT} \leq 150\text{ mA}$	2.425	2.5	2.575	V
Output Voltage for 3.3 V Option	$7.3\text{ V} < V_{IN} < 16\text{ V}$, $100\text{ }\mu\text{A} \leq I_{OUT} \leq 150\text{ mA}$	3.234	3.3	3.366	V
	$5.5\text{ V} < V_{IN} < 26\text{ V}$, $100\text{ }\mu\text{A} \leq I_{OUT} \leq 150\text{ mA}$	3.201	3.3	3.399	V
Output Voltage for 5.0 V Option	$9.0\text{ V} < V_{IN} < 16\text{ V}$, $100\text{ }\mu\text{A} \leq I_{OUT} \leq 150\text{ mA}$	4.90	5.0	5.10	V
	$6.0\text{ V} < V_{IN} < 26\text{ V}$, $100\text{ }\mu\text{A} \leq I_{OUT} \leq 150\text{ mA}$	4.85	5.0	5.15	V
Output Voltage for 8.0 V Option	$9.0\text{ V} < V_{IN} < 26\text{ V}$, $100\text{ }\mu\text{A} \leq I_{OUT} \leq 150\text{ mA}$	7.76	8.0	8.24	V
Output Voltage for 10 V Option	$11\text{ V} < V_{IN} < 26\text{ V}$, $100\text{ }\mu\text{A} \leq I_{OUT} \leq 150\text{ mA}$	9.7	10	10.3	V
Output Voltage for Adjustable Option	$V_{OUT} = V_{ADJ}$ (Unity Gain)				
	$6.5\text{ V} < V_{IN} < 16\text{ V}$, $100\text{ }\mu\text{A} < I_{OUT} < 150\text{ mA}$	1.254	1.280	1.306	V
	$5.5\text{ V} < V_{IN} < 26\text{ V}$, $100\text{ }\mu\text{A} < I_{OUT} < 150\text{ mA}$	1.242	1.280	1.318	V
Dropout Voltage ($V_{IN} - V_{OUT}$) (5.0 V, 8.0 V, 10 V, and Adj. > 5.0 V Options Only)	$I_{OUT} = 150\text{ mA}$	-	400	600	mV
	$I_{OUT} = 1.0\text{ mA}$	-	100	150	mV
Load Regulation	$V_{IN} = 14\text{ V}$, $5.0\text{ mA} \leq I_{OUT} \leq 150\text{ mA}$	-30	5.0	30	mV
Line Regulation	$[V_{OUT}(\text{Typ}) + 1.0] < V_{IN} < 26\text{ V}$, $I_{OUT} = 1.0\text{ mA}$	-	15	60	mV
Quiescent Current, Low Load 2.5 V Option 3.3 V Option 5.0 V Option 8.0 V Option 10 V Option Adjustable Option	$I_{OUT} = 100\text{ }\mu\text{A}$, $V_{IN} = 12\text{ V}$, $\text{MON} = V_{OUT}$	-	90	125	μA
		-	90	125	μA
		-	90	125	μA
		-	100	150	μA
		-	100	150	μA
		-	50	75	μA
		-	50	75	μA
Quiescent Current, Medium Load All Options	$I_{OUT} = 75\text{ mA}$, $V_{IN} = 14\text{ V}$, $\text{MON} = V_{OUT}$	-	4.0	6.0	mA
Quiescent Current, High Load All Options	$I_{OUT} = 150\text{ mA}$, $V_{IN} = 14\text{ V}$, $\text{MON} = V_{OUT}$	-	12	19	mA
Quiescent Current, (I_Q) Sleep Mode	ENABLE = 0 V, $V_{IN} = 12\text{ V}$	-	12	30	μA

4. Voltage range specified in the Output Stage of the Electrical Characteristics in boldface type.

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ELECTRICAL CHARACTERISTICS (continued) ($I_{OUT} = 1.0 \text{ mA}$, $ENABLE = 5.0 \text{ V}$, $-40^{\circ}\text{C} \leq T_A \leq 125^{\circ}\text{C}$; $-40^{\circ}\text{C} \leq T_J \leq 150^{\circ}\text{C}$; V_{IN} dependent on voltage option (Note 5); unless otherwise specified.)

Characteristic	Test Conditions	Min	Typ	Max	Unit
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Output Stage

Current Limit	-	160	300	-	mA
Short Circuit Output Current	$V_{OUT} = 0 \text{ V}$	40	190	-	mA
Thermal Shutdown	(Guaranteed by Design)	150	180	-	$^{\circ}\text{C}$

Reset Function (RESET)

RESET Threshold for 2.5 V Option HIGH (V_{RH}) LOW (V_{RL})	$5.5 \text{ V} \leq V_{IN} \leq 26 \text{ V}$ (Note 6) V_{OUT} Increasing V_{OUT} Decreasing	2.28	2.350	$0.98 \times V_{OUT}$	V
		2.25	2.300	$0.97 \times V_{OUT}$	V
RESET Threshold for 3.3 V Option HIGH (V_{RH}) LOW (V_{RL})	$5.5 \text{ V} \leq V_{IN} \leq 26 \text{ V}$ (Note 6) V_{OUT} Increasing V_{OUT} Decreasing	3.00	3.102	$0.98 \times V_{OUT}$	V
		2.97	3.036	$0.97 \times V_{OUT}$	V
RESET Threshold for 5.0 V Option HIGH (V_{RH}) LOW (V_{RL})	V_{OUT} Increasing V_{OUT} Decreasing	4.55	4.70	$0.98 \times V_{OUT}$	V
		4.50	4.60	$0.97 \times V_{OUT}$	V
RESET Threshold for 8.0 V Option HIGH (V_{RH}) LOW (V_{RL})	V_{OUT} Increasing V_{OUT} Decreasing	6.86	7.52	$0.98 \times V_{OUT}$	V
		6.80	7.36	$0.97 \times V_{OUT}$	V
RESET Threshold for 10 V Option HIGH (V_{RH}) LOW (V_{RL})	V_{OUT} Increasing V_{OUT} Decreasing	8.60	9.40	$0.98 \times V_{OUT}$	V
		8.50	9.20	$0.97 \times V_{OUT}$	V
Output Voltage Low (V_{RLO}) Low ($V_{R(PEAK)}$)	$1.0 \text{ V} \leq V_{OUT} \leq V_{RL}$, $R_{RESET} = 10 \text{ k}$ V_{OUT} , Power up, Power down	-	0.1	0.4	V
		-	0.6	1.0	V
DELAY Switching Threshold (V_{DT})	-	1.4	1.8	2.2	V
DELAY Low Voltage	$V_{OUT} < \overline{\text{RESET}}$ Threshold Low(min)	-	-	0.1	V
DELAY Charge Current	DELAY = 1.0 V, $V_{OUT} > V_{RH}$	1.5	2.5	3.5	μA
DELAY Discharge Current	DELAY = 1.0 V, $V_{OUT} = 1.5 \text{ V}$	5.0	-	-	mA

FLAG/Monitor

Monitor Threshold	Increasing and Decreasing	1.10	1.20	1.31	V
Hysteresis	-	20	50	100	mV
Input Current	MON = 2.0 V	-0.5	0.1	0.5	μA
Output Saturation Voltage	MON = 0 V, $I_{FLAG} = 1.0 \text{ mA}$	-	0.1	0.4	V

Voltage Adjust (Adjustable Output only)

Input Current	$V_{ADJ} = 1.28 \text{ V}$	-0.5	-	0.5	μA
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ENABLE

Input Threshold	Low	-	-	0.5	V
	High	3.0	-	-	V
Input Current	ENABLE = 5.0 V	-	1.0	5.0	μA

5. Voltage range specified in the Output Stage of the Electrical Characteristics in boldface type.

6. For $V_{IN} \leq 5.5 \text{ V}$, a RESET = Low may occur with the output in regulation.

NCV8501 Series

PACKAGE PIN DESCRIPTION, ADJUSTABLE OUTPUT

Package Pin Number		Pin Symbol	Function
SO-8	SOW-16 E PAD		
1	7	V_{IN}	Input Voltage.
2	8	MON	Monitor. Input for early warning comparator. If not needed connect to V_{OUT} .
3	9	ENABLE	ENABLE control for the IC. A high powers the device up.
4	3-6, 10-12, 14, 15	NC	No connection.
5	13	GND	Ground. All GND leads must be connected to Ground.
6	16	\overline{FLAG}	Open collector output from early warning comparator.
7	1	V_{ADJ}	Voltage Adjust. A resistor divider from V_{OUT} to this lead sets the output voltage.
8	2	V_{OUT}	$\pm 2.0\%$, 150 mA output.

PACKAGE PIN DESCRIPTION, FIXED OUTPUT

Package Pin Number		Pin Symbol	Function
SO-8	SOW-16 E PAD		
1	7	V_{IN}	Input Voltage.
2	8	MON	Monitor. Input for early warning comparator. If not needed connect to V_{OUT} .
3	9	ENABLE	ENABLE control for the IC. A high powers the device up.
4	10	DELAY	Timing capacitor for \overline{RESET} function.
5	13	GND	Ground. All GND leads must be connected to Ground.
6	16	\overline{RESET}	Active reset (accurate to $V_{OUT} \geq 1.0\text{ V}$)
7	1	\overline{FLAG}	Open collector output from early warning comparator.
8	2	V_{OUT}	$\pm 2.0\%$, 150 mA output.
-	3-6, 11, 12, 14, 15	NC	No connection.

TYPICAL PERFORMANCE CHARACTERISTICS

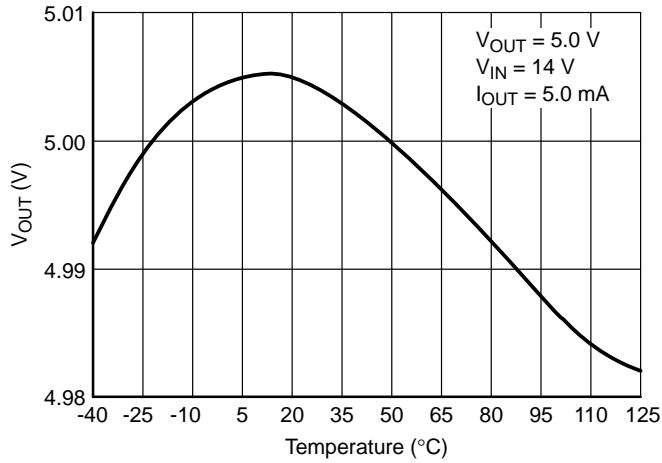


Figure 2. Output Voltage vs Temperature

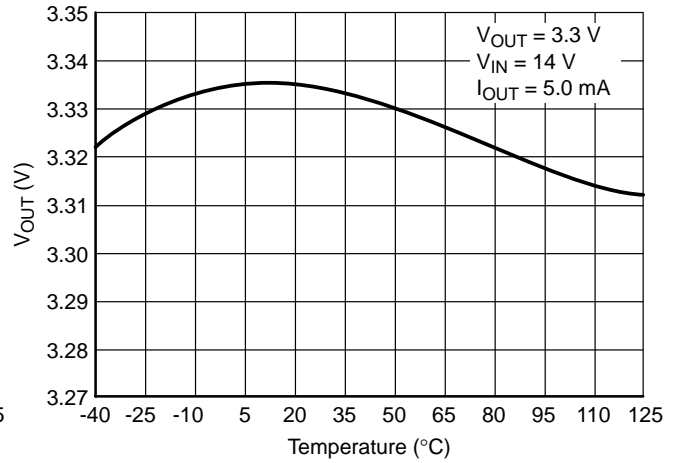


Figure 3. Output Voltage vs Temperature

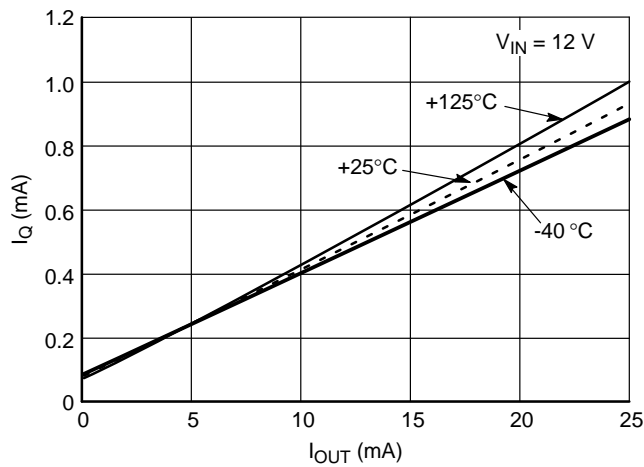


Figure 4. Quiescent Current vs Output Current

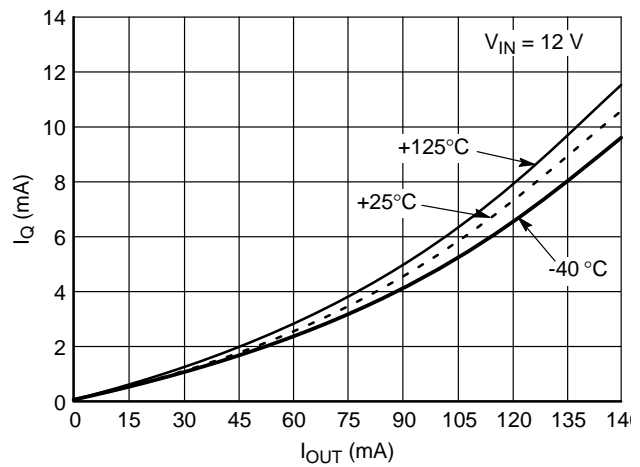


Figure 5. Quiescent Current vs Output Current

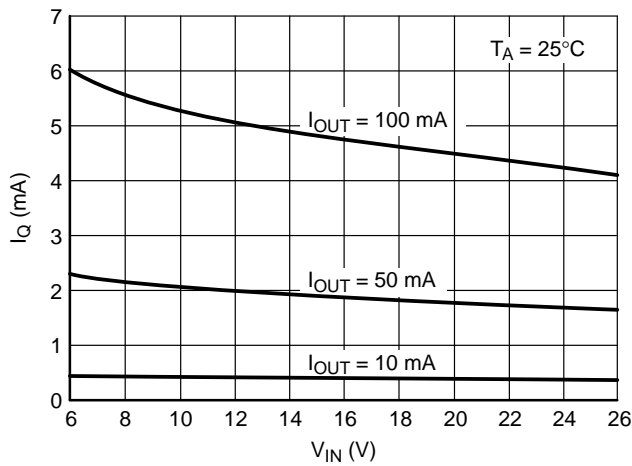


Figure 6. Quiescent Current vs Input Voltage

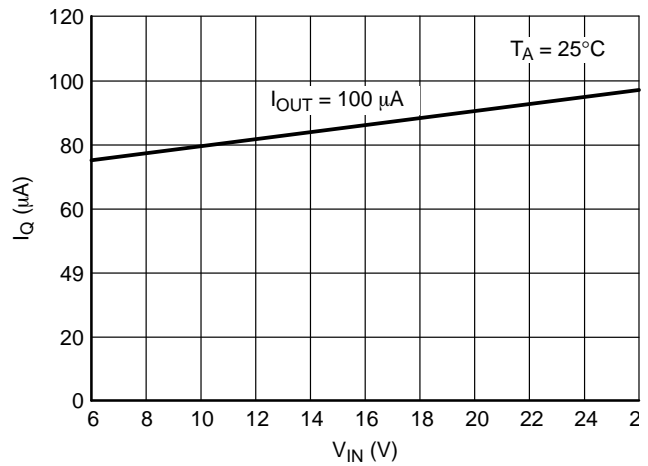


Figure 7. Quiescent Current vs Input Voltage

NCV8501 Series

TYPICAL PERFORMANCE CHARACTERISTICS

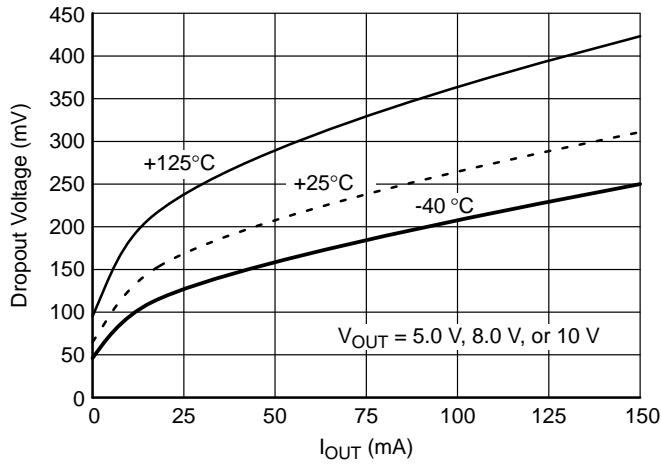


Figure 8. Dropout Voltage vs Output Current

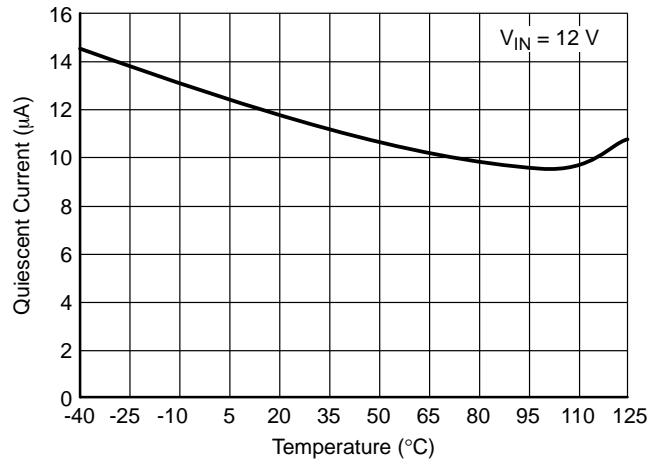


Figure 9. Sleep Mode I_Q vs Temperature

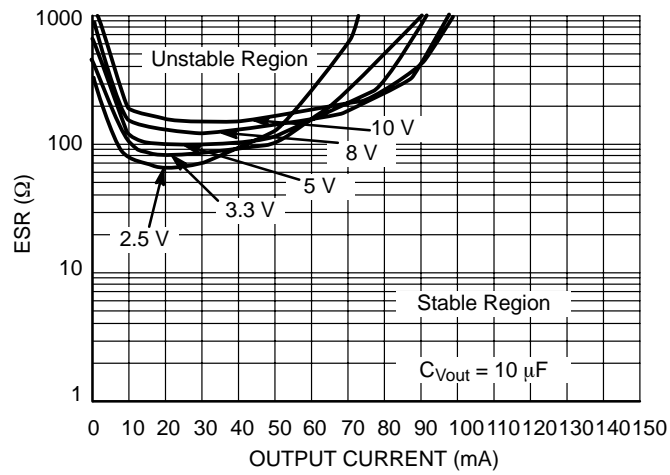


Figure 10. Output Capacitor ESR

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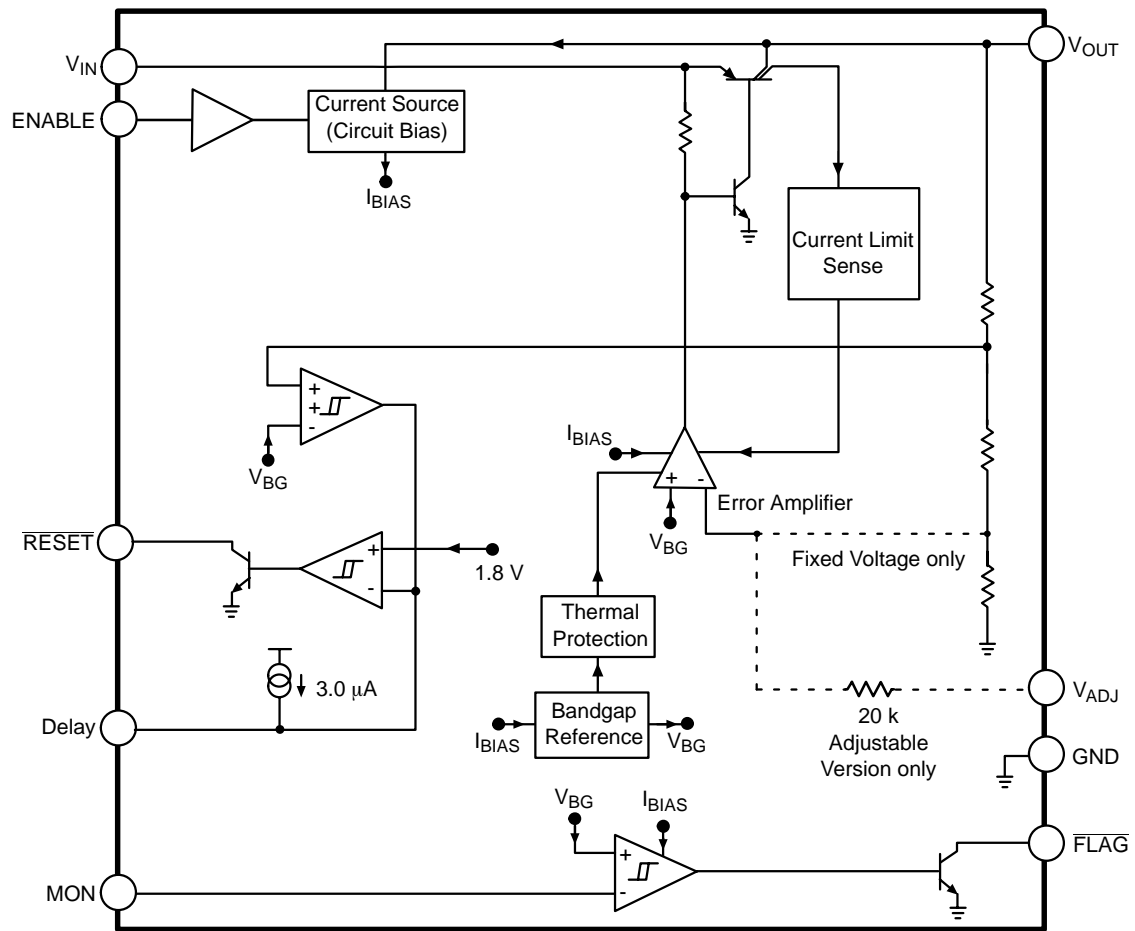


Figure 11. Block Diagram

CIRCUIT DESCRIPTION

REGULATOR CONTROL FUNCTIONS

The NCV8501 contains the microprocessor compatible control function $\overline{\text{RESET}}$ (Figure 12).

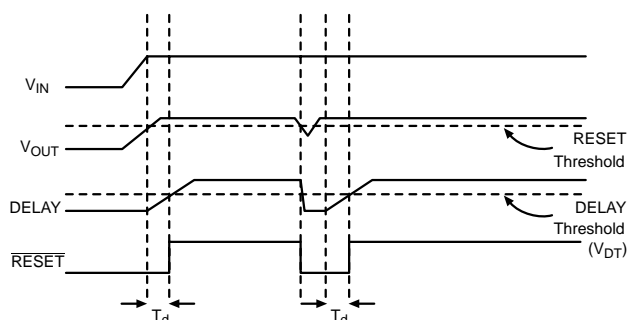


Figure 12. Reset and Delay Circuit Wave Forms

$\overline{\text{RESET}}$ Function

A $\overline{\text{RESET}}$ signal (low voltage) is generated as the IC powers up until V_{OUT} is within 6.0% of the regulated output voltage, or when V_{OUT} drops out of regulation, and is lower than 8.0% below the regulated output voltage. Hysteresis is included in the function to minimize oscillations.

The $\overline{\text{RESET}}$ output is an open collector NPN transistor, controlled by a low voltage detection circuit. The circuit is functionally independent of the rest of the IC thereby guaranteeing that the $\overline{\text{RESET}}$ signal is valid for V_{OUT} as low as 1.0 V.

ENABLE Function

The part stays in a low I_{Q} sleep mode when the ENABLE pin is held low. The part has an internal pull down if the pin is left floating. This is intended for failure modes only. An external connection (active pulldown, resistor, or switch) for normal operation is recommended.

The integrity of the ENABLE pin allows it to be tied directly to the battery line through an external resistor. It will withstand load dump potentials in this configuration.

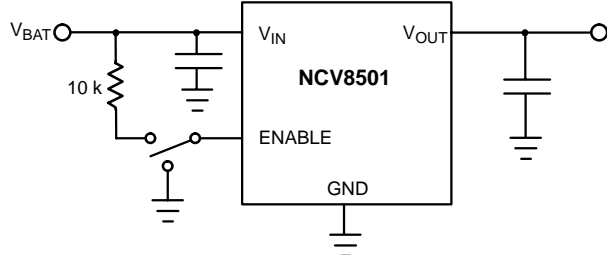


Figure 13. ENABLE Function

DELAY Function

The reset delay circuit provides a programmable (by external capacitor) delay on the $\overline{\text{RESET}}$ output lead.

The DELAY lead provides source current (typically 2.5 μA) to the external DELAY capacitor during the following proceedings:

1. During Power Up (once the regulation threshold has been verified).
2. After a reset event has occurred and the device is back in regulation. The DELAY capacitor is discharged when the regulation ($\overline{\text{RESET}}$ threshold) has been violated. This is a latched incident. The capacitor will fully discharge and wait for the device to regulate before going through the delay time event again.

FLAG/Monitor Function

An on-chip comparator is provided to perform an early warning to the microprocessor of a possible reset signal. The reset signal typically turns the microprocessor off instantaneously. This can cause unpredictable results with the microprocessor. The signal received from the FLAG pin will allow the microprocessor time to complete its present task before shutting down. This function is performed by a comparator referenced to the bandgap reference. The actual trip point can be programmed externally using a resistor divider to the input monitor (MON) (Figure 14).

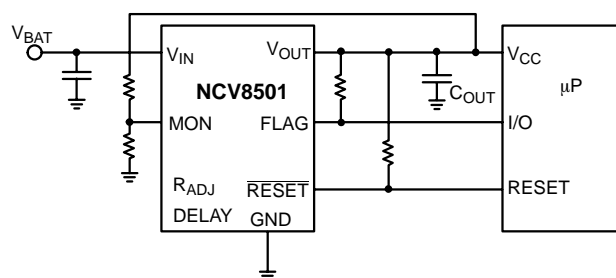


Figure 14. Flag/Monitor Function

Voltage Adjust

Figure 15 shows the device setup for a user configurable output voltage. The feedback to the V_{ADJ} pin is taken from a voltage divider referenced to the output voltage. The loop is balanced around the Unity Gain threshold (1.28 V typical).

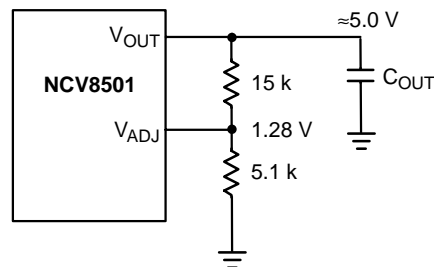


Figure 15. Adjustable Output Voltage

APPLICATION NOTES

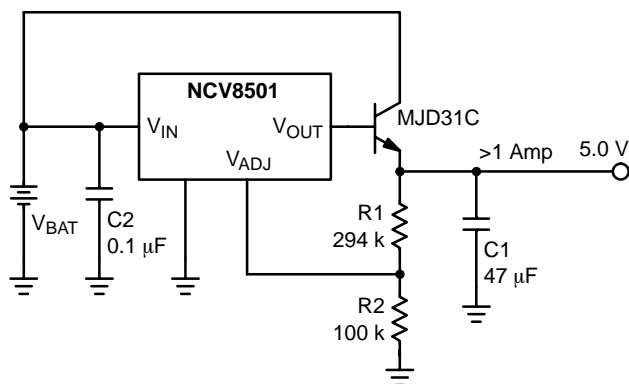


Figure 16. Additional Output Current

Adding Capability

Figure 16 shows how the adjustable version of parts can be used with an external pass transistor for additional current capability. The setup as shown will provide greater than 1 Amp of output current.

FLAG MONITOR

Figure 17 shows the FLAG Monitor waveforms as a result of the circuit depicted in Figure 14. As the output voltage falls (V_{OUT}), the Monitor threshold is crossed. This causes the voltage on the \overline{FLAG} output to go low sending a warning signal to the microprocessor that a \overline{RESET} signal may occur in a short period of time. $T_{WARNING}$ is the time the microprocessor has to complete the function it is currently working on and get ready for the \overline{RESET} shutdown signal.

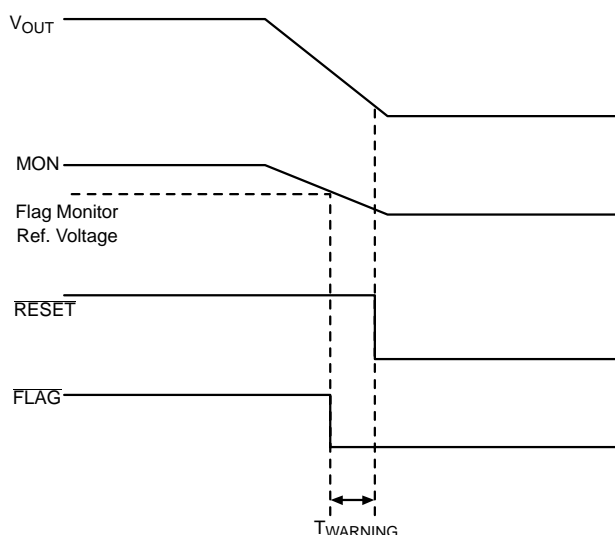
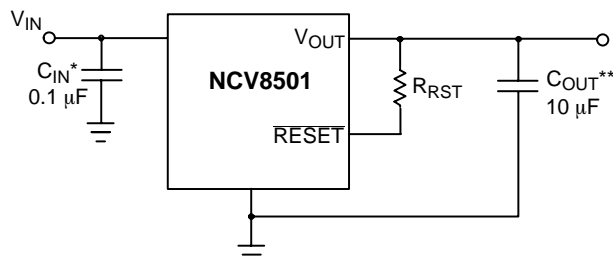


Figure 17. FLAG Monitor Circuit Waveform



* C_{IN} required if regulator is located far from the power supply filter

** C_{OUT} required for stability. Capacitor must operate at minimum temperature expected

Figure 18. Test and Application Circuit Showing Output Compensation

SETTING THE DELAY TIME

The delay time is controlled by the Reset Delay Low Voltage, Delay Switching Threshold, and the Delay Charge Current. The delay follows the equation:

$$t_{DELAY} = \frac{[C_{DELAY}(V_{dt} - \text{Reset Delay Low Voltage})]}{\text{Delay Charge Current}}$$

Example:

Using $C_{DELAY} = 33 \text{ nF}$.

Assume reset Delay Low Voltage = 0.

Use the typical value for $V_{dt} = 1.8 \text{ V}$.

Use the typical value for Delay Charge Current = $2.5 \mu\text{A}$.

$$t_{DELAY} = \frac{[33 \text{ nF}(1.8 - 0)]}{2.5 \mu\text{A}} = 23.8 \text{ ms}$$

STABILITY CONSIDERATIONS

The output or compensation capacitor helps determine three main characteristics of a linear regulator: start-up delay, load transient response and loop stability.

The capacitor value and type should be based on cost, availability, size and temperature constraints. A tantalum or aluminum electrolytic capacitor is best, since a film or ceramic capacitor with almost zero ESR can cause instability. The aluminum electrolytic capacitor is the least expensive solution, but, if the circuit operates at low temperatures (-25°C to -40°C), both the value and ESR of the capacitor will vary considerably. The capacitor manufacturers data sheet usually provides this information.

The value for the output capacitor C_{OUT} shown in Figure 18 should work for most applications, however it is not necessarily the optimized solution.

CALCULATING POWER DISSIPATION IN A SINGLE OUTPUT LINEAR REGULATOR

The maximum power dissipation for a single output regulator (Figure 19) is:

$$P_{D(max)} = [V_{IN(max)} - V_{OUT(min)}]I_{OUT(max)} + V_{IN(max)}I_Q \quad (1)$$

where:

$V_{IN(max)}$ is the maximum input voltage,

$V_{OUT(min)}$ is the minimum output voltage,

$I_{OUT(max)}$ is the maximum output current for the application, and

I_Q is the quiescent current the regulator consumes at $I_{OUT(max)}$.

Once the value of $P_{D(max)}$ is known, the maximum permissible value of $R_{\theta JA}$ can be calculated:

$$R_{\theta JA} = \frac{150^{\circ}\text{C} - T_A}{P_D} \quad (2)$$

The value of $R_{\theta JA}$ can then be compared with those in the package section of the data sheet. Those packages with $R_{\theta JA}$'s less than the calculated value in equation 2 will keep the die temperature below 150°C .

In some cases, none of the packages will be sufficient to dissipate the heat generated by the IC, and an external heatsink will be required.

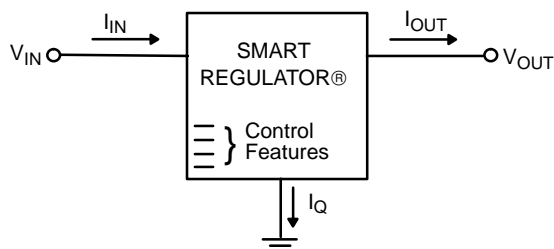


Figure 19. Single Output Regulator with Key Performance Parameters Labeled

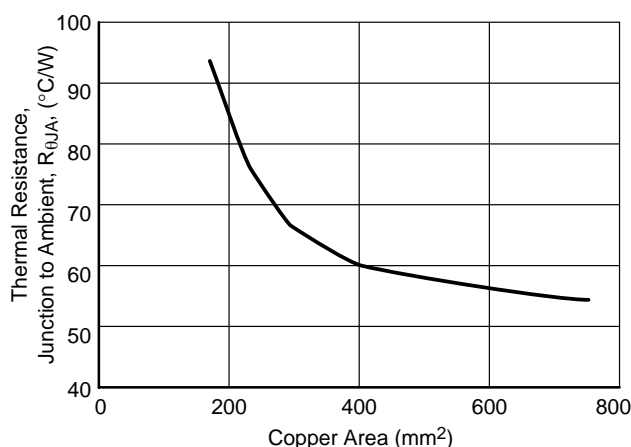


Figure 20. 16 Lead SOW (Exposed Pad), θ_{JA} as a Function of the Pad Copper Area (2 oz. Cu Thickness), Board Material = 0.0625" G-10/R-4

HEAT SINKS

A heat sink effectively increases the surface area of the package to improve the flow of heat away from the IC and into the surrounding air.

Each material in the heat flow path between the IC and the outside environment will have a thermal resistance. Like series electrical resistances, these resistances are summed to determine the value of $R_{\theta JA}$:

$$R_{\theta JA} = R_{\theta JC} + R_{\theta CS} + R_{\theta SA} \quad (3)$$

where:

$R_{\theta JC}$ = the junction-to-case thermal resistance,

$R_{\theta CS}$ = the case-to-heatsink thermal resistance, and

$R_{\theta SA}$ = the heatsink-to-ambient thermal resistance.

$R_{\theta JC}$ appears in the package section of the data sheet. Like $R_{\theta JA}$, it too is a function of package type. $R_{\theta CS}$ and $R_{\theta SA}$ are functions of the package type, heatsink and the interface between them. These values appear in heat sink data sheets of heat sink manufacturers.

NCV8501 Series

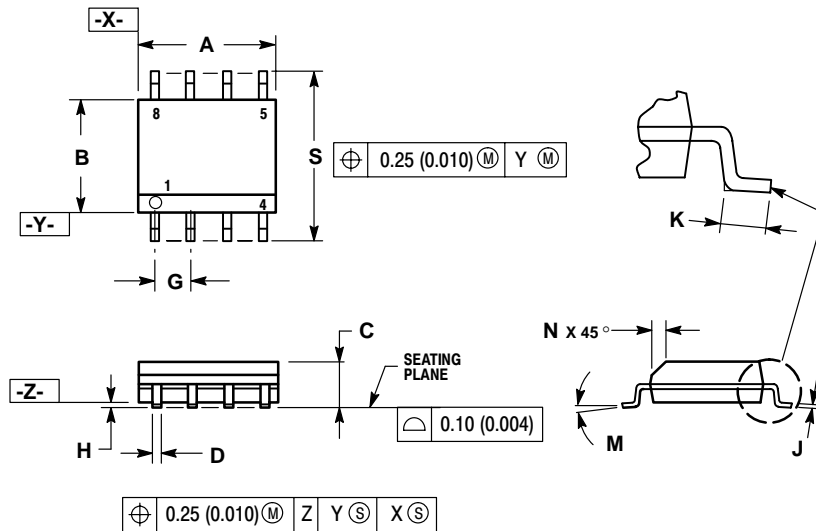
ORDERING INFORMATION

Device	Output Voltage	Package	Shipping
NCV8501DADJ	Adjustable	SO-8	98 Units/Rail
NCV8501DADJR2			2500 Tape & Reel
NCV8501PDWADJ		SOW-16 Exposed Pad	47 Units/Rail
NCV8501PDWADJR2			1000 Tape & Reel
NCV8501D25	2.5 V	SO-8	98 Units/Rail
NCV8501D25R2			2500 Tape & Reel
NCV8501PDW25		SOW-16 Exposed Pad	47 Units/Rail
NCV8501PDW25R2			1000 Tape & Reel
NCV8501D33	3.3 V	SO-8	98 Units/Rail
NCV8501D33R2			2500 Tape & Reel
NCV8501PDW33		SOW-16 Exposed Pad	47 Units/Rail
NCV8501PDW33R2			1000 Tape & Reel
NCV8501D50	5.0 V	SO-8	98 Units/Rail
NCV8501D50R2			2500 Tape & Reel
NCV8501PDW50		SOW-16 Exposed Pad	47 Units/Rail
NCV8501PDW50R2			1000 Tape & Reel
NCV8501D80	8.0 V	SO-8	98 Units/Rail
NCV8501D80R2			2500 Tape & Reel
NCV8501PDW80		SOW-16 Exposed Pad	47 Units/Rail
NCV8501PDW80R2			1000 Tape & Reel
NCV8501D100	10 V	SO-8	98 Units/Rail
NCV8501D100R2			2500 Tape & Reel
NCV8501PDW100		SOW-16 Exposed Pad	47 Units/Rail
NCV8501PDW100R2			1000 Tape & Reel

NCV8501 Series

PACKAGE DIMENSIONS

SO-8
D SUFFIX
CASE 751-07
ISSUE AA



NOTES:

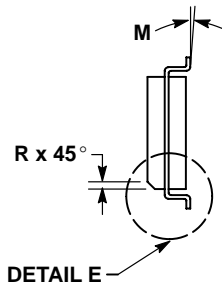
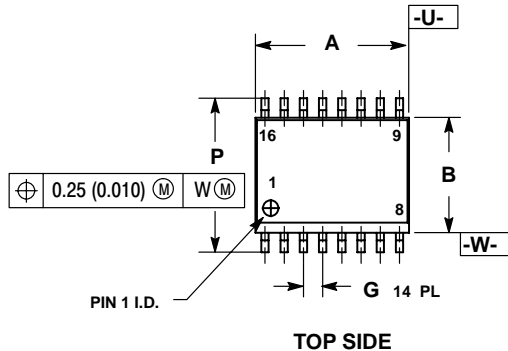
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSION A AND B DO NOT INCLUDE MOLD PROTRUSION.
4. MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.
5. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.
6. 751-01 THRU 751-06 ARE OBSOLETE. NEW STANDAAARD IS 751-07

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	4.80	5.00	0.189	0.197
B	3.80	4.00	0.150	0.157
C	1.35	1.75	0.053	0.069
D	0.33	0.51	0.013	0.020
G	1.27 BSC		0.050 BSC	
H	0.10	0.25	0.004	0.010
J	0.19	0.25	0.007	0.010
K	0.40	1.27	0.016	0.050
M	0°	8°	0°	8°
N	0.25	0.50	0.010	0.020
S	5.80	6.20	0.228	0.244

NCV8501 Series

PACKAGE DIMENSIONS

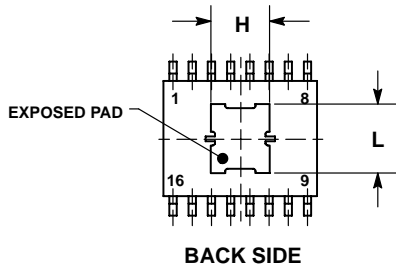
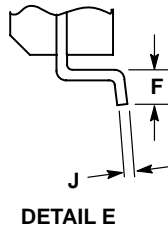
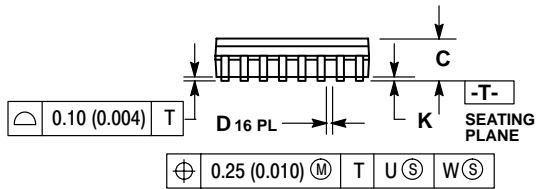
SOIC 16 LEAD WIDE BODY
EXPOSED PAD
PDW SUFFIX
CASE 751R-02
ISSUE A




NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSION A AND B DO NOT INCLUDE MOLD PROTRUSION.
4. MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.
5. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE PROTRUSION SHALL BE 0.13 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.
6. 751R-01 OBSOLETE, NEW STANDARD 751R-02.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	10.15	10.45	0.400	0.411
B	7.40	7.60	0.292	0.299
C	2.35	2.65	0.093	0.104
D	0.35	0.49	0.014	0.019
F	0.50	0.90	0.020	0.035
G	1.27 BSC		0.050 BSC	
H	3.76	3.86	0.148	0.152
J	0.25	0.32	0.010	0.012
K	0.10	0.25	0.004	0.009
L	4.58	4.78	0.180	0.188
M	0°	7°	0°	7°
P	10.05	10.55	0.395	0.415
R	0.25	0.75	0.010	0.029



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